

SPECIFICATION

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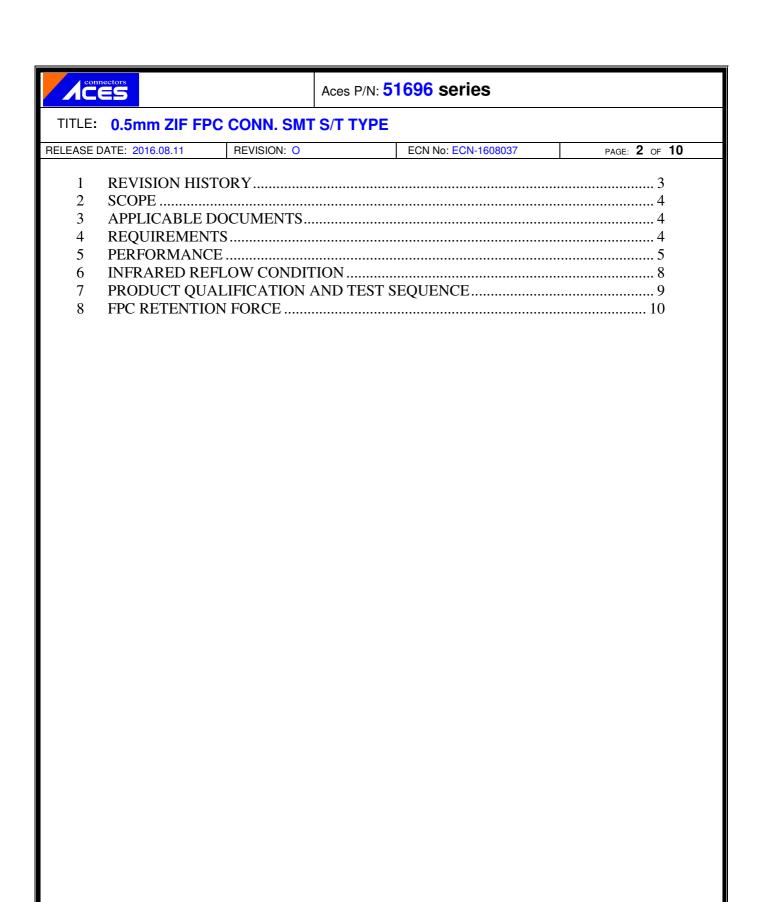
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SPEC. NO.:	PS-516	96-XXXXX-XXX	REVISION:	O
PRODUCT N	NAME:	0.5mm ZIF FPC CON	IN. SMT S/T TYPE	
PRODUCT N	iO:	51696 SERIES		

PREPARED:	CHECKED:	APPROVED:
XUBIN	BRAVE	FRANK
DATE: 2016.08.11	DATE: 2016.08.11	DATE: 2016.08.11



TLE: 0.	5mm ZIF FPC	CONN. SMT	S/T TYPE					
ASE DATE:	2016.08.11	REVISION: 0		ECN No: ECN-1608037	PAG	GE: 3 OF 10		
Revision History								
Rev.	ECN#		Revision De	escription	Prepared	Date		
0	ECN-1608037	7 NEW SPEC)		XUBIN	2016/8/11		



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2 SCOPE

This specification covers performance, tests and quality requirements for **0.5mm ZIF FPC CONN. SMT S/T TYPE**

3 APPLICABLE DOCUMENTS

EIA-364: ELECTRONICS INDUSTRIES ASSOCIATION

4 REQUIREMENTS

- 4.1 Design and Construction
 - 4.1.1 Product shall be of design, construction and physical dimensions specified on applicable product drawing.
 - 4.1.2 All materials conform to R.o.H.S. and the standard depends on TQ-WI-140101.
- 4.2 Materials and Finish
 - 4.2.1 Contact: High performance copper alloy (Phosphor Bronze)

Finish: (a) Contact Area: Refer to the drawing.

(b) Under plate: Refer to the drawing.

(c) Solder area: Refer to the drawing.

- 4.2.2 Housing: Thermoplastic or Thermoplastic High Temp., UL94V-0
- 4.2.3 Actuator: Thermoplastic or Thermoplastic High Temp., UL94V-0
- 4.2.4 Fitting Nail: Copper Alloy, Finish: Refer to the drawing.
- 4.3 Ratings
 - 4.3.1 Working voltage less than 36 volts (per pin)
 - 4.3.2 Voltage: 50 Volts AC (per pin)
 - 4.3.3 Current: 0.5 Amperes (per pin)
 - 4.3.4 Operating Temperature : -40°C to +85°C



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5 Performance

5.1. Test Requirements and Procedures Summary

Item	Requirement	Standard
Examination of Product	Product shall meet requirements of applicable product drawing and	per applicable quality inspection
	specification. ELECTRICAL	plan.
Item	Requirement	Standard
Low Level Contact Resistance	20 m Ω Max.(initial)per contact 20 m Ω Max. Change allowed	Mate connectors, measure by dry circuit, 20mV Max., 100mA Max. (EIA-364-23)
Insulation Resistance	50 M Ω Min.	Unmated connectors, apply 500 V DC between adjacent terminals. (EIA-364-21)
Dielectric Withstanding Voltage	No discharge, flashover or breakdown. Current leakage: 1 mA max.	250 VAC Min. at sea level for 1 minute. Test between adjacent contacts of unmated connectors. (EIA-364-20)
Temperature Rise	30°C Max. Change allowed	Mate connector: measure the temperature rise at rated current until temperature stable. The ambient condition is still air at 25°C (EIA-364-70, METHOD1,CONDITION1)



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MECHANICAL						
Item	Requirement	Standard				
Durability	30 cycles.	The sample should be mounted in the tester and fully mated and unmated the number of cycles specified at the rate of 25.4 ± 3mm/min. (EIA-364-09)				
FPC Retention Force	See Page 10	A connector shall be soldered on a board and insert the actuator, pull the FPC at the speed rate of 25.4 ± 3 mm/min.				
Terminal /Housing Retention Force	0.3kgf MIN.	Operation Speed: 25.4 ± 3 mm/minute. Measure the contact retention force with tester.				
Fitting Nail /Housing Retention Force	0.3kgf MIN.	Operation Speed: 25.4 ± 3 mm/minute. Measure the contact retention force with tester.				
Vibration	1 μs Max.	The electrical load condition shall be 100 mA maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of 10 and 55 Hz. The entire frequency range, from 10 to 55 Hz and return to 10 Hz, shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. (EIA-364-28 Condition I)				
Shock (Mechanical)	1 μs Max.	Subject mated connectors to 50 G's (peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be 100mA maximum for all contacts. (EIA-364-27, test condition A)				



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ENVIRONMENTAL							
Item	Requirement	Standard					
Resistance to Wave Soldering Heat	See Product Qualification and Test Sequence Group 10 (Lead Free)	Solder Temp. : 265±5°C, 10±0.5sec.					
Resistance to Reflow Soldering Heat	See Product Qualification and Test Sequence Group 10 (Lead Free)	Pre Heat: 150°C~180°C, 60~120sec. Heat: 230°C Min., 40sec Min. Peak Temp.: 260°C Max, 10sec Max.					
Thermal Shock	See Product Qualification and Test Sequence Group 4	Mate module and subject to follow condition for 5 cycles. 1 cycles: -55 +0/-3 °C, 30 minutes +85 +3/-0 °C, 30 minutes (EIA-364-32, test condition I)					
Humidity	See Product Qualification and Test Sequence Group 4	Mated Connector 40°C, 90~95% RH, 96 hours. (EIA-364-31,Condition A, Method II)					
Temperature Life	See Product Qualification and Test Sequence Group 5	Subject mated connectors to					
Salt Spray (Only For Gold Plating)	See Product Qualification and Test Sequence Group 6	Subject mated/unmated connectors to 5% salt-solution concentration, 35°C (I) Gold flash for 8 hours (II) Gold plating 5 u" for 96 hours. (EIA-364-26)					
Solder ability	Tin plating: Solder able area shall have minimum of 95% solder coverage. Gold plating: Solder able area shall have minimum of 75% solder coverage	And then into solder bath, Temperature at 245 ±5°C, for 4-5 sec. (EIA-364-52)					
Hand Soldering Temperature Resistance	Appearance: No damage	T≧350°C, 3sec at least.					

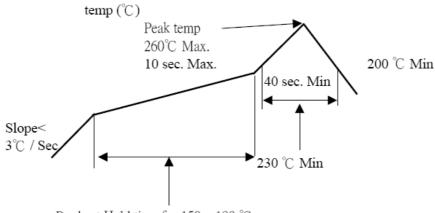
Note. Flowing Mixed Gas shell be conduct by customer request.

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6 INFRARED REFLOW CONDITION

TEMPERATURE CONDITION GRAPH (TEMPERATURE ON BOARD PATTERN SIDE)



Pre-heat Hold time for $150 \sim 180$ °C is $60 \sim 120$ sec.

connectors

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7 PRODUCT QUALIFICATION AND TEST SEQUENCE

	Test Group										
Test or Examination	1	2	3	4	5	6	7	8	9	10	11
					Test	Sequ	ence				
Examination of Product				1、7	1、6	1 \ 4				1	1
Low Level Contact Resistance		1 \ 5	1 \ 4	2 \ 10	2 \ 9	2 \ 5				3	
Insulation Resistance				3 · 9	3 · 8						
Dielectric Withstanding Voltage				4 . 8	4 · 7						
Temperature Rise	1										
Durability		3									
Vibration			2								
Shock (Mechanical)			3								
Thermal Shock				5							
Humidity				6							
Temperature Life					5						
Salt Spray(Only For Gold Plating)						3					
Solder ability							1				
FPC Retention Force		2 · 4									
Terminal / Housing Retention Force									1		
Fitting Nail /Housing Retention Force									2		
Resistance to Soldering Heat										2	
Hand Soldering Temperature Resistance											2
Sample Size	2	4	4	4	4	4	2	4	4	4	4



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8 FPC RETENTION FORCE

NO.OF		After	NO.OF		After		
CKT.	Initial	Durability	CKT.	Initial	Durability		
4							
5	0.20	0.15	33	0.85	0.75		
6			34	0.03	0.75		
7			35				
8	0.30	0.25	36				
9	0.30	0.23	37				
10			38	0.95	0.85		
11			39				
12			40				
13	0.45	0.35	41				
14			42		0.90		
15			43	1.00			
16			44				
17			45				
18	0.55	0.45	46				
19			47				
20			48	1.10	1.00		
21			49				
22			50				
23	0.65	0.55	51				
24			52				
25			53				
26			54				
27			55	1.20	1.10		
28	0.75	0.65	56	1.20	1.10		
29			57				
30			58				
31	0.05	0.75	59				
32	0.85	0.75	60				